INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99) Application Number 10769684 Filing Date 2004-01-30 First Named Inventor S.P. Bonilla Art Unit 2166 Examiner Name Leon J. Harper Attorney Docket Number SJ0920030093US17

				U.S.	PATENTS	Remove			
Examiner Initial*	Cite No	Patent Number	Kind Code ¹	Issue Date	Name of Patentee or Applicant of cited Document	Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear			
/LH/	1	7085839		2006-08-01	Baugher et al.				
/LH/	2	6131121		2000-10-10	Mattaway et al.				
/LH/	3	6317748		2001-11-13	Menzies et al.				
If you wish to add additional U.S. Patent citation information please click the Add button. Add									
U.S.PATENT APPLICATION PUBLICATIONS Remove									
Examiner Initial*	Cite No	Publication Number	Kind Code ¹	Publication Date	Name of Patentee or Applicant of cited Document	Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear			
/LH/	1	20040024483		2004-02-05	Holcombe				
/LH/	2	20040088347		2004-05-06	Yeager et al.				
/LH/	3	20040133640		2004-07-08	Yeager et al.				

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Not for submission under 37 CFR 1.99)

Application Number		10769684		
Filing Date		2004-01-30		
First Named Inventor S.P. E		Bonilla		
Art Unit		2166		
Examiner Name Leon		J. Harper		
Attorney Docket Number		SJO920030093US17		

	4	20050172258		2005-08-04		Nixon et al.					
If you wish to add additional U.S. Published Application citation information please click the Add button. Add											
FOREIGN PATENT DOCUMENTS Remove											
Examiner Initial*	Cite No	Foreign Document Number ³	Country Code ² i		nd ode4	Publication Date	Name of Patentee Applicant of cited Document	e Or	Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear	T5	
/LH/	1	2001184324	JP			2001-07-06	Toshiba Eng Co Ltd	1			
/LH/	2	2002157172	JP			2002-05-31	Hitachi Ltd				
If you wis	h to ac	dd additional Foreign P	atent Doc	ument cita	ation	information pl	ease click the Add	button	Add		
			NON-	PATENT	LITE	RATURE DO	CUMENTS		Remove		
Examiner Initials*	Cite No	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc), date, pages(s), volume-issue number(s), publisher, city and/or country where published.								T5	
	1										
If you wis	h to ac	dd additional non-paten	t literature	e documer	nt cit	ation informati	on please click the	Add b	utton Add		
				EXAM	IINE	R SIGNATUR	 E				
Examiner Signature /Leon Harper/							Date Conside	red	04/14/2008		
*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through a citation if not in conformance and not considered. Include copy of this form with next communication to applicant.											
¹ See Kind Codes of USPTO Patent Documents at www.USPTO.GOV or MPEP 901.04. ² Enter office that issued the document, by the two-letter code (WIPO Standard ST.3). ³ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁴ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. ⁵ Applicant is to place a check mark here if English language translation is attached.											